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Multilayer Ceramic Chip Capacitors

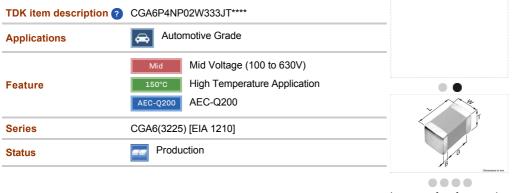
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Size

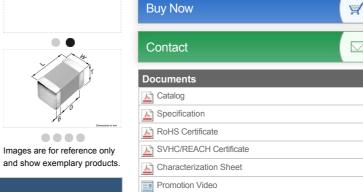
**Products** 



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Sample Kits

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Length(L)	3.20mm ±0.40mm
Width(W)	2.50mm ±0.30mm
Thickness(T)	2.50mm ±0.30mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	2.00mm to 2.40mm
Recommended Land Pattern (PB)	1.00mm to 1.20mm
Recommended Land Pattern (PC)	1.90mm to 2.50mm

Electrical Characteristics	
Capacitance	33nF ±5%
Rated Voltage	450VDC
Temperature Characteristic ?	NP0(0±30ppm/°C)
Q (Min.)	1000
Insulation Resistance (Min.)	10000ΜΩ
Other	

Other	
Soldering Method	Reflow
AEC-Q200	Yes
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	1000pcs

## Characteristic Graph (This is reference data, and does not guarantee the products characteristics.)





Frequency/Hz

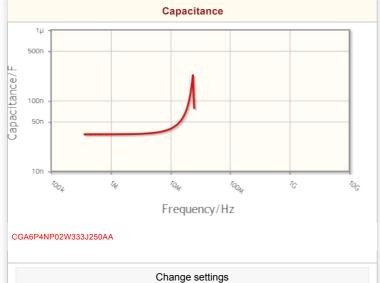
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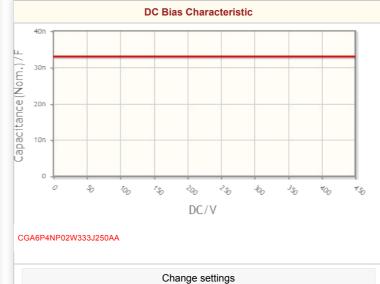
Change settings

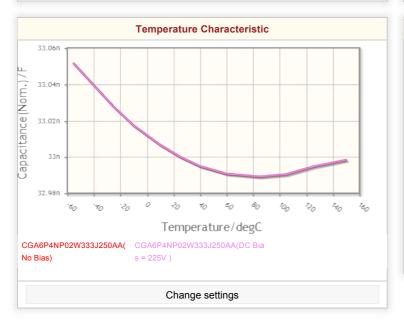
Frequency/Hz

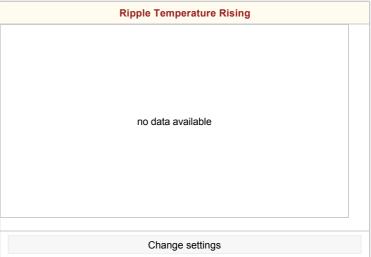
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- » Sensors and Sensor Systems
- » Ceramic Switching / Heating, Piezo Components,

Buzzers and Microphones

- » Transformers
- » Ferrites and Accessories
- » Noise Suppressing / Magnetic Sheet

- » Anechoic Chambers and Radio Wave Absorbers
  - » Power Supplies
- » Magnets
- » Flash Storages
- » Wireless Power Transfer
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